

10A, 100V Low V_F Trench Schottky Surface Mount Rectifier

FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss / high efficiency
- High forward surge capability
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

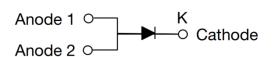
- Case: TO-277A (SMPC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.095g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	10	Α	
V_{RRM}	100	V	
I _{FSM}	140	Α	
T _{J MAX}	150	°C	
Package	TO-277A (SMPC)		
Configuration	Single die		





TO-277A (SMPC)



PARAMETER	SYMBOL	TSP10U100S	UNIT
Marking code on the device		10U100	
Repetitive peak reverse voltage	V _{RRM}	100	V
Reverse voltage, total rms value	V _{R(RMS)}	70	V
Forward current	I _F	10	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	140	А
Junction temperature	T_J	-55 to +150	°C
Storage temperature	T _{STG}	-55 to +150	°C



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	11	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 5A, T_J = 25^{\circ}C$		0.51	-	V
	$I_F = 10A, T_J = 25^{\circ}C$	V _F	0.60	0.68	V
	I _F = 5A, T _J = 125°C		0.42	-	V
	I _F = 10A, T _J = 125°C		0.52	0.60	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	150	μA
	T _J = 125°C	- I _R	-	30	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TSP10U100S	TO-277A (SMPC)	6,000 / Tape & Reel



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

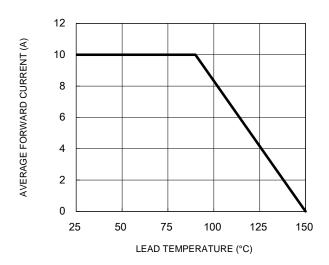


Fig.3 Typical Reverse Characteristics

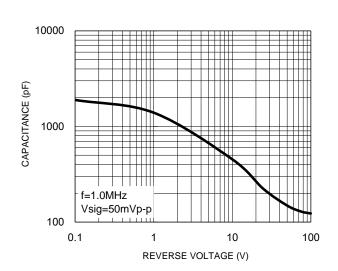
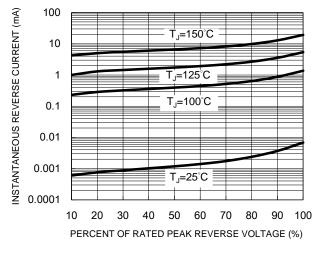


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



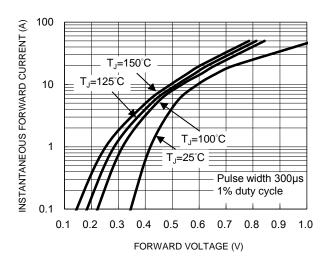
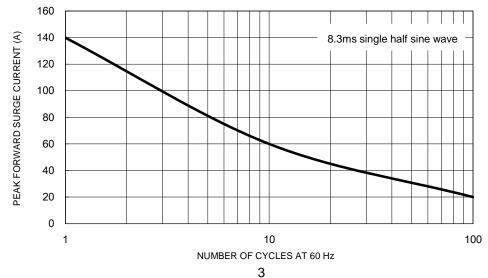


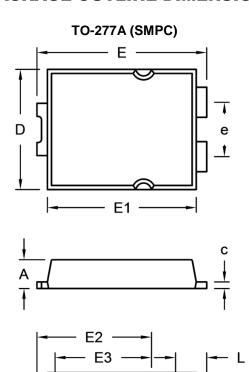
Fig.5 Maximum Non-Repetitive Forward Surge Current







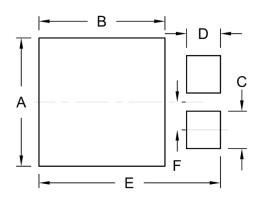
PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
Α	1.000	1.200	0.039	0.047
b	1.000	1.300	0.039	0.051
b2	1.850	2.150	0.073	0.085
С	0.175	0.325	0.007	0.013
D	4.550	4.650	0.179	0.183
D2	3.170	3.470	0.125	0.137
E	6.350	6.650	0.250	0.262
E1	5.650	5.750	0.222	0.226
E2	4.235	4.535	0.167	0.179
E3	3.540	3.840	0.139	0.151
е	1.930	2.230	0.076	0.088
L	1.043	1.343	0.041	0.053

SUGGESTED PAD LAYOUT

D2 b2



Symbol	Unit (mm)	Unit (inch)
Α	4.80	0.189
В	4.72	0.186
С	1.40	0.055
D	1.27	0.050
E	6.80	0.268
F	1.04	0.041

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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